



Certified Reference Material

Certificate of Analysis

ISO 17034:2016

ISO/IEC 17025:2017

Revision No.: 000

Revision Date: 10/03/2022



Product ID: MBH-74X WS-21

Product Description: Tin-base (Lead-Free) Solder

Description and Intended Use: This Certified Reference Material is covered under the scope of accreditation to ISO 17034 by LGC Standards - Manchester, NH. As an ISO 17034 certified reference material, appropriate use of this material will fulfill the certified reference material and traceability requirements for use in ISO 17025 accredited laboratories. This CRM may come in the form of a solid disk, or chips. The intended use of this CRM may include, but is not limited to, the calibration of instruments and the validation of analytical methods.

Certified Values listed in wt.% with associated uncertainties

Ag	0.309 ±0.006	Cd	0.0015 ±0.0002	ln	0.007 ±0.001	Sb	1.50	± 0.02
As	0.010 ±0.002	Cu	4.62 ±0.02	Ni	0.0057 ±0.0004	Zn	0.0007	± 0.0002
Bi	0.007 ±0.001	Fe	0.0015 ±0.0006	Pb	0.040 ±0.001			

Indicative Values listed in ppm

Al (6) Au (5) P (116) Sn Balance

Homogeneity and Uncertainty: "Uncertainty" values, as reported adjacent to certified concentration values, are based on a 95% Confidence Interval. These estimated uncertainties include the combined effects of method imprecision, material inhomogeneity, and any bias between methods. Homogeneity data from experimental XRF results are reflected in both the overall statistics and certified data. Homogeneity samples are selected by a systematic sampling procedure. The number of samples may be determined by equation 1, where N_{prod} is the number of units produced and N_{min} is the number of samples used for homogeneity testing. These samples are arranged in a simple randomized design such that each sample is analyzed multiple times by XRF. Homogeneity may also be determined within sample using an applied version of ASTM E826. A single factor ANOVA is used to calculated uncertainty due to inhomogeneity (U_{hom}). Uncertainty of the material is calculated by equation 2, where $H=U_{hom}$, $S=S_{tot}$ Standard deviation, $t=t_{tot}$ and $t=t_{tot}$ and $t=t_{tot}$ and $t=t_{tot}$ and $t=t_{tot}$ calculated by equation 2.

1.
$$N_{MIN} = \max(10, \sqrt[3]{N_{PROD}})$$
 2. $U_{CRM} = \frac{\sqrt{H^2 + S^2}}{\sqrt{n}} * t$

Certification Laboratories: Much of the analytical work performed to assess this material has been carried out by laboratories with proven competence, as indicated by their accreditation to ISO 17025. It is an implicit requirement for this accreditation that analytical work should be performed with due traceability, via an unbroken chain of comparisons, each with stated uncertainty, to primary standards such as the mole, or to nationally- or internationally-recognised reference materials. Of the individual results herein, some have traceability (to the mole) via primary analytical methods. Some are traceable to substances of known stoichiometry. Most have traceability via commercial solutions. Furthermore, some results have additional traceability to NIST standards, as part of the analytical calibration or process control.

- Connecticut Metallurgical, Inc. East Hartford, CT
- Dirats Laboratories Westfield, MA
- EAG Laboratories Liverpool, MA
- Laboratory Testing, Inc. Hatfield, PA
- LGC Standards Manchester, NH
- Lukasiewicz Instytut Metali Niezelaznych Gliwice, Poland
- Luvak Inc Boylston, MA
- NSL Analytical Services Cleveland, OH
- SGS MSi Melrose Park, IL
- Sheffield Assay Office Sheffield, England
- TEC Eurolab Campogalliano, Italy
- Universal Scientific Laboratory Pty Ltd New South Wales, Australia

Instructions for Use: The test surface is on the opposite side of the labeled surface, which includes the material identification. This material is individually chill cast per piece. This manner of casting can cause the formation of inhomogeneous segregates in the upper, engraved portion of the disk. Therefore, the certification information above is not applicable to within 3mm of the engraved surface. Each packaged disk has been prepared by finishing the test surface using a lathe. The user must determine the correct surface preparation procedure for each analytical technique. The user is cautioned to use care when either resurfacing the disk or performing additional polishing, as these processes may contaminate the surface. The minimum sample size for chips should be individually evaluated based on the analytical technique used; this would typically be greater than 0.1 grams. The material should be stored in a cool, dry location when not in use. Chips are not recommended for gas analysis.

Period of Validity: The certification of this material is valid indefinitely, within the uncertainty specified, provided the material is handled and stored in accordance with the instructions stated on this certificate. The certification is nullified if the material is damaged, contaminated, otherwise modified, or used in a manner for which it was not intended.

Chuck Goudreau, Certifying Officer

3 October 2022 Certification Date ISO 17034 Accredited: Reference Materials Producer, Certificate # 2848.02 ISO/IEC 17025 Accredited: Chemical Testing, Certificate # 2848.01



The following data represents all pertinent information reported as it applies to the chemical characterization of this material.

	Ag	Al	As	Au	Bi	Cd	Cu	Fe	ln	Ni	Р
1	0.2977	0.0002	0.0057	0.0002	0.0050	0.0010	4.550	0.0003	0.0049	0.0047	0.0030
2	0.2980	0.0002	0.0079	0.0003	0.0061	0.0010	4.578	0.0009	0.0050	0.0047	0.0060
3	0.3032	0.0003	0.0094	0.0005	0.0062	0.0013	4.590	0.0010	0.0052	0.0050	0.0093
4	0.3086	0.0007	0.0100	0.0006	0.0064	0.0013	4.594	0.0010	0.0061	0.0052	0.0100
5	0.3090	0.0010	0.0119	0.0006	0.0065	0.0015	4.610	0.0018	0.0062	0.0056	0.0113
6	0.3093	0.0010	0.0120	0.0010	0.0068	0.0015	4.611	0.0018	0.0064	0.0057	0.0115
7	0.3100	<0.0005	0.0121	<0.0005	0.0074	0.0015	4.612	0.0022	0.0072	0.0060	0.0126
8	0.3120	<0.0005	0.0123	<0.001	0.0088	0.0015	4.619	0.0023	0.0087	0.0061	0.0130
9	0.3151	<0.001	0.0128	<0.0010	0.0093	0.0017	4.621	0.0025	0.0087	0.0061	0.0140
10	0.3240	< 0.005				0.0019	4.660	<0.0005	0.0100	0.0062	0.0250
11						0.0020	4.677	<0.0010	0.0103	0.0062	<0.005
12						0.0022	4.680		0.0110	0.0064	
13						<0.0005				0.0065	
Mean	0.3087	0.0006	0.0105	0.0005	0.0070	0.0015	4.617	0.0015	0.0075	0.0057	0.0116
STDV	0.0079	0.0004	0.0024	0.0003	0.0014	0.0004	0.039	0.0008	0.0022	0.0006	0.0058
Certified	0.309	(0.0006)	0.01	(0.0005)	0.007	0.0015	4.62	0.0015	0.007	0.0057	(0.0116)
U _{CRM}	0.006		0.002		0.001	0.0002	0.02	0.0006	0.001	0.0004	
Methods	I,X,O	I,IM,G	IM,I	I,IM,G	IM,I	IM,I,O,G	I,O	I,IM,G	I,IM,O,G	IM,I,X,O,G	I,IM,X,G

	Pb	Sb	Zn
1	0.0370	1.469	0.0005
2	0.0370	1.472	0.0006
3	0.0378	1.474	0.0006
4	0.0385	1.479	0.0007
5	0.0395	1.490	0.0007
6	0.0397	1.497	0.0007
7	0.0398	1.497	0.0013
8	0.0400	1.503	<0.0005
9	0.0400	1.510	<0.001
10	0.0403	1.520	<0.0010
11	0.0421	1.525	
12	0.0450	1.555	
13		1.568	
Mean	0.0397	1.505	0.0007
STDV	0.0022	0.031	0.0003
Certified	0.04	1.5	0.0007
Ucrm	0.001	0.02	0.0002
Methods	I,O,G	I,X,O	I,IM,G

Legend: W = Classical, C = Combustion, F = Fusion, A = AA or GFAA, I = ICP or DCP, IM=ICP-MS, D = DC Arc, O = AES, X = XRF, G = GDAES or GDMS, H = Hollow Cathode AES

